PLEDxUSW Series, Unidirectional, White DO-214AA



OBSOLETE DATE: 03/26/2020 PCN/ECN# 41325 REPLACED BY: PLED series



Agency Approvals

Agency

Agency File Number



E133083

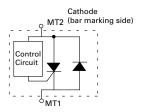
Description

The PLEDxUSW open LED protectors provide an electronic switching shunt path around a single LED that fails as an open circuit. This ensures the remaining string of LEDs will continue to function even though a single LED in the string has failed open. It also provides reverse battery or reverse power polarity protection.

It is designed to enable higher reliability in outdoor LED lighting applications such as street lighting, outdoor signage, aircraft runway lighting, roadside warning lights and other applications. Additionally, it is molded from white material to make it less visible in the LED fixture and the white molding also reflects more light to improve overall light engine efficiency.

This component is compatible with one, two and three watt LEDs that have a nominal 3V forward characteristic, PLEDxUSW is available in SMB surface mount package. The DO-214AA (SMB) low profile package is ideal for dense board applications.

Schematic Symbol



Features & Benefits

- Fast switching
- Reverse Battery/Power Protection
- Automatically resets after power cycle
- Low profile, small foot print standard DO-214AA package
- Compatible with industrial lighting environments

- IEC-61000-4-2 ESD 30kV (Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2
- Compatible with PWM frequencies up to 10 kHz
- RoHS compliant and halogen-free
- Moisture Sensitivity Level(MSL -1)

Electrical Characteristics (All parameters are measured at T_a=25°C unless otherwise noted)

Part Number	Marking	break	BR down	V _{DRM} breakdown	I _H	I _s	I _T @V _T	V _τ @ I _τ =1Α	I _F @V _F	V _F @ I _F =1A	l _o ¹	Critical rate of rise dV/dt
			lts	Volts	mAmps	mAmps	Amps	Volts	Amps	Volts	Amps	Volts
		Min	Max	Min	Max	Max	Max	Max	Max	Max	Min	Max
PLED6USW	PL6UW	6	16	6	30	50	1.0	1.2	1.0	1.0	1.0	250V/µs

note

1. $\rm I_{o}\text{-}$ Operation current tested @ aluminum boards, ambient temp 85°C

Thermal Considerations

Package	Symbol Parameter		Value	Unit
DO-214AA in White	T _J	Operating Junction Temperature Range	-40 to +150	°C
P	T _s Storage Temperature Range		-65 to +150	°C
	R _{eJA}	Thermal Resistance: Junction to Ambient	DO-214AA: 90 ¹ DO-214AA: 40 ²	°C/W

Notes:

1) Standard FR-4 PCB with Copper Pads (Recommended Size)

2) Aluminum PCB

Thickness: 1.6mm

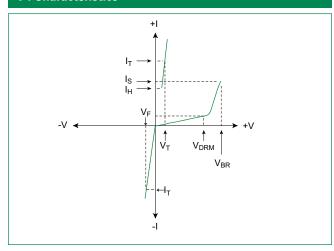
Grade: 1-2 W/mK Thermal Conductivity

Trace thickness: 2 oz

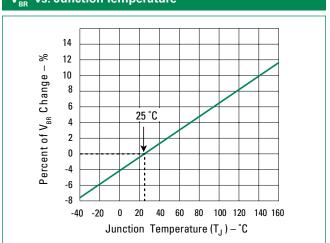
Insulation layer thickness: 215 um

Solder Pad Dimensions: 2.0mm x 2.8mm (Recommended Size)

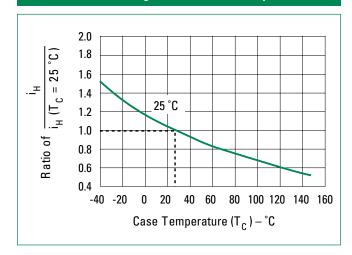
V-I Characteristics



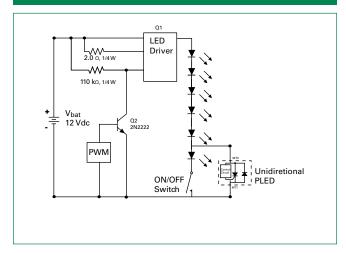
V_{BB} vs. Junction Temperature



Normalized DC Holding Current vs. Case Temperature



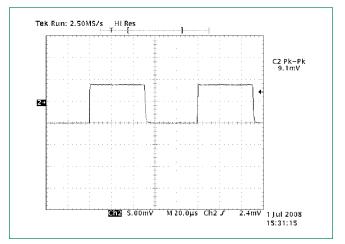
LED Interference Test Circuit



6 LEDs in Series 50% Duty Cycle 10kHz

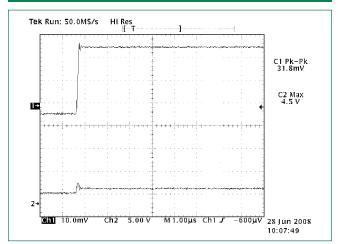
Tek Run: 2.50MS/s Hi Res C1 Pk-Pk 8.9mV M 20.0μs Ch1 J 6mV 25 Jun 2008 13:18:23

5 LEDs and 1 PLED in Series 50% Duty Cycle 10kHz



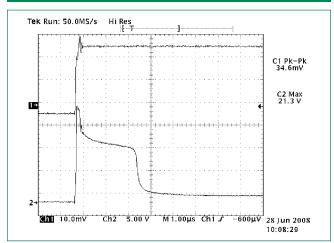
Note: These two graphs show the current magnitude through the LED string with and without the PLED included. There is no noticeable effect on the LED current magnitude when the PLED is included in the circuit as compared to the LED current magnitude when the PLED is not in the circuit. (The conversion factor for the test measurement in the graphs above is 10mA/mV for the Pearson coil measurement, therefore, the current magnitude in the first figure is 10mA*8.9 = 89mA, while the second figure is 91mA.)

PLED in the Off-State 10kHz



Channel 1: current through LEDs (318 mA) Channel 2: voltage across PLED device (4.5 V)

PLED device zeners and then turns fully on 10kHz



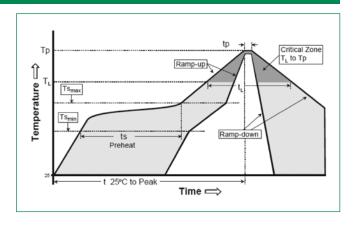
Channel 1: current through LEDs (346 mA) and PLED device once it is fully turned on 2.5 µsec later Channel 2: voltage across PLED device (21.3 V before PLED crowbars with 2 V drop)

Soldering Parameters

Reflow Co	ndition	Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average ra	amp up rate (Liquidus Temp k	3°C/second max	
T _{S(max)} to T _L	- Ramp-up Rate	3°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	-Temperature (t _L)	60 – 150 seconds	
PeakTemp	erature (T _P)	260 ^{+0/-5} °C	
Time with Temperate	in 5°C of actual peak ure (t _p)	30 seconds	
Ramp-dov	vn Rate	6°C/second max	
Time 25°C	to peakTemperature (T _P)	8 minutes max	
Do not exc	ceed	260°C	



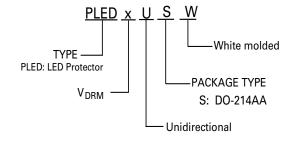
Terminal Material	Copper Alloy	
Terminal Finish	100% Matte Tin Plated	
Body Material	UL recognized compound meeting flammability classification V-0	



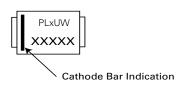
Environmental Specifications

High Temperature Voltage Blocking	MIL-STD-750: Method 1040, Condition A 80% min V _{DRM} (VAC-peak), 150°C, 504 hours
Temperature Cycling	MIL-STD-750: Method 1051 -65°C to 150°C, 15-minute dwell, 100 cycles
Biased Temperature & Humidity	EIA/JEDEC: JESD22-A101 52VDC, 85°C, 85%RH, 1008 hours
High Temperature Storage	MIL-STD-750: Method 1031 150°C, 1008 hours
Low Temperature Storage	-65°C, 1008 hours
Thermal Shock	MIL-STD-750: Method 1056 0°C to 100°C, 5-minute dwell, 10-second transfer, 10 cycles
Resistance to Solder Heat	MIL-STD-750: Method 2031 260°C, 10 seconds

Part Numbering System

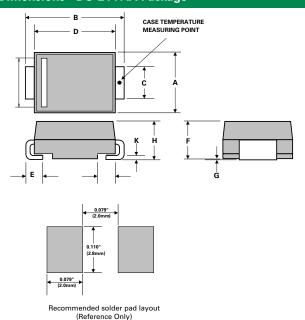


Part Marking System



Packaging					
Package	Description	Packaging Quantity	Industry Standard		
S	DO-214AA	2500	EIA-481-1		

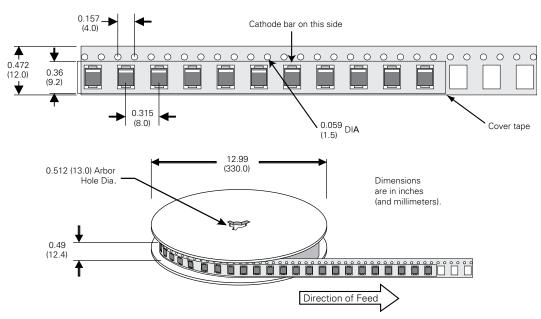
Dimensions - DO-214 AA Package



Dimensions	Incl	nes	Millimeters		
Dimensions	Min	Max	Min	Max	
А	0.130	0.156	3.30	3.95	
В	0.201	0.220	5.10	5.60	
С	0.077	0.087	1.95	2.20	
D	0.159	0.181	4.05	4.60	
E	0.030	0.063	0.75	1.60	
F	0.075	0.096	1.90	2.45	
G	0.002	0.008	0.05	0.20	
Н	0.077	0.104	1.95	2.65	
K	0.006	0.016	0.15	0.41	

DO-214AA Embossed Carrier Reel Pack (RP)

Meets all EIA-481-1 Standards



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